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NOTES : 1. MATERIAL : INSULATOR : UL 94V-0, LCP+30%G/F, CO SIGNAL CONTACTS : PHOSPHOR BRONZE, C CD/WP CONTACTS : Ti-Cu, TICUR1-M-EH. SHIELD: STAINLESS STEEL SUS-301.	C5210R-SH.		RT NUM 022711—		IIL	VOID :	NON LEA			
2. PLATING SPEC: CONTACT: 50u" Min NICKEL UNDERPLATED 100u" Min TIN/LEAD OR MATTE SELECTIVE GOLD PLATED ON COL	TIN ON SOLDER TAIL AREA,					DID : P P : 1	EAD FREE VC TRAY. TAPE & R _ATING :			
<ol> <li>3. PRODUCT SPECIFICATION: GS-12-241.</li> <li>4. PACKAGING SPECIFICATION: GS-14-851.</li> </ol>					1:0	GOLD FL	ASH OVE			
<ol> <li>CARD PULLING-OUT FORCE EXCEED 0.36K0 UNDER LOCKING-CONDITION.</li> </ol>	3F(3.5N)									
<ol> <li>MULTIMEDIA CARD COMPATIBLE.</li> <li>WP: WRITE PROTECT CD: CARD DETECT INDICATION</li> </ol>										
8. LEAD FREE NOTES:										
8.1. THE HOUSING WILL WITHSTAND EXPO	SURE TO 260°C PEAK									
TEMPERATURE FOR 10 SECONDS IN										
PHASE REFLOW OVEN.										
8.2. THIS PRODUCT (10022711-00XXLF) I										
DIRECTIVE AS DESCRIBED IN GS-22										
DIRECTIVE AS DESCRIDED IN 03 22	000.									
	mat'l. c	ode			tolerances unless otherwise specified		CUSTOMER	FCI		
	ltr ecr	no dr	date		.X ±. .XX ±	.38	COPY projection	- S)	www	.fciconn
	н			linear	.XXX ±	±.10		SD CAR	D HEADER P	USH
				angles dr JAS	0" ± SMINE CHIANG		₩ MM	product family	y MEMORY	
				engr	JASON HSU	8/20/03'		size dwg no	)	
					JASON HSU JAMES HSU	8/20/03' 8/20/03'	scale N/A	A4 1C	02271	1
	sheet	revision								$\square$
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